

# Xinyu Zhang

No. 333, Longfei Avenue, Longcheng Street, Longgang District, Shenzhen, Guangdong Province

🏠 [xinyuzhangxy.github.io](https://github.com/xinyuzhangxy) | ✉ [xinyuzhangdlut@gmail.com](mailto:xinyuzhangdlut@gmail.com)



## Education Background

---

### Dalian University of Technology

*Sept. 2017 – Jun. 2020*

MASTER OF CHEMICAL ENGINEERING (ELECTROCHEMICAL ENGINEERING) GPA: 3.64/5.00 (86.4/100)

**Academic courses:** Theoretical Electrochemistry; Electrochemical Power Source; Photoelectrocatalytic Materials; Corrosion and Corrosion Control.

**Research Areas:** Surface & interface; Metal corrosion; Semiconductor; Electrodeposition & electroless deposition.

### Dalian University of Technology

*Sept. 2013 – Jun. 2017*

BACHELOR OF ELECTROCHEMICAL ENGINEERING GPA: 3.60/5.00 (86.0/100) Ranking: 4/30

**Academic Courses:** Electrochemistry; Chemical Power Techniques; Physical Examination in Material Technology; Metallic Corrosion.

**Research Areas:** Electrochemistry; Anti-corrosion coating; Semiconductor; Electrochemical water treatment.

## Work Experience

---

### SAIC VOLKSWAGEN Automotive Co., Ltd. (Shanghai)

*Aug. 2020 – Nov. 2021*

AUTOMOTIVE ENGINEER - Focusing on the anti-corrosion design of body-in-white and battery pack shell.

## Research Experience

---

### Electrochemical Engineering Laboratory, Dalian University of Technology

*Sept. 2017 – Jun. 2020*

STUDENT RESEARCHER AT [ELECTROCHEMICAL ENGINEERING LAB](#), ADVISED BY [PROF. LIDA WANG](#)

**Topic:** Research on the corrosion promotion mechanism of semiconductor material/metal galvanic system

**Topic 1:** Study on the corrosion promotion mechanism of TiO<sub>2</sub> semiconductor fillers on copper

- Investigated the influence of the crystal type and morphology of TiO<sub>2</sub> semiconductor fillers on the corrosion behavior of copper by LEIS and EIS.
- Proposed a mechanism of TiO<sub>2</sub> promoting copper corrosion in dark conditions, based on the Ohmic contact, electrical conductivity and oxygen reduction activity of TiO<sub>2</sub> by SKP, RRDE, and M-S test.
- Provided the basis of selecting semiconductor as anticorrosive fillers and the crystal structure design of semiconductor fillers.

**Topic 2:** Research on the corrosion promotion mechanism of corrosion product semiconductors on iron

- Investigated the influence of five iron corrosion product semiconductors on iron corrosion behavior by SVET.
- Elaborated on the "corrosion promoting activity" of the corrosion product semiconductors on iron, based on the whole corrosion process and the nature of the corrosion products.
- Analyzed the influence of semiconductor crystal phase transition on the "corrosion promoting activity" of the semiconductor.
- Proposed preliminarily a basis for judging whether semiconductors have "corrosion promoting activity" on metals.

### Electrochemical Engineering Laboratory, Dalian University of Technology

*Feb. 2017 – Jun. 2017*

STUDENT RESEARCHER AT [ELECTROCHEMICAL ENGINEERING LAB](#), ADVISED BY [PROF. GUICHANG LIU](#) & [PROF. WEN SUN](#)

**Topic:** Study on influence of different semiconductor materials in composite coatings on metal corrosion behavior

- Investigated the influence of three types of semiconductor fillers ( $\text{TiO}_2$ ,  $\text{Fe}_2\text{O}_3$  and  $\text{Cu}_2\text{O}$ ) on metal corrosion under damaged coatings by LEIS, EIS, EN, and SEM.
- Explained preliminarily the reason for the "corrosion promotion activity" of semiconductor filler, based on the work function and oxygen reduction activity.

## Publications

---

1. **X. Zhang**, S. Li, W. Sun, L. Wang, J. Wang, G. Liu, "Study on the corrosion behavior of copper coupled with  $\text{TiO}_2$  with different crystal structures", *Corrosion Science*, 2021, 183: 109352. (Journal Impact Factor/JCR Quartile: **7.72/Q1**)
2. **X. Zhang**, L. Wang, W. Sun, Y. He, X. Shu, G. Liu, "Effect of Corrosion Products of Pure Iron on the Corrosion Behavior of Pure Iron and Its Mechanism", *Materials Protection (Chinese Letters)*, 2021, 54(7): 30-36.
3. Li S, Sun W, Yang Z, **X. Zhang**, L. Wang, G. Liu, "Influences of semiconductor oxide fillers on the corrosion behavior of metals under coatings", *Electrochimica Acta*, 2018, 292: 425-434. (Journal Impact Factor/JCR Quartile: **7.336/Q1**)

## Highlighted Projects

---

1. **Preparation and performance study of conductive anticorrosive coating on stainless steel bipolar plates**  
*Aug. 2018 – May. 2019*
  - Prepared the stainless steel electrode with Ni/Ni-Mo-P/Cr-C multilayer coating by electrodeposition and electroless deposition.
  - The corrosion current density and the interface contact resistance of treated electrode in the acidic simulated fuel cell environment at  $70^\circ\text{C}$  are  $0.85\mu\text{A}/\text{cm}^2$  and  $4.5\text{m}\Omega\cdot\text{cm}^2$ , which meets the performance requirements for bipolar plates ( $I < 1\mu\text{A}/\text{cm}^2$ ,  $\text{ICR} < 10\text{m}\Omega\cdot\text{cm}^2$ ).
2. **Corrosion failure analysis of circulating water system of oil refining equipment and development of water quality improvement device**  
*Oct. 2016 – Jan. 2017*
  - Analyzing the circulating water quality, equipment material, and corrosion inhibitor performance, the oxygen concentration corrosion induced by cohesive sediment leads to equipment corrosion failure.
  - Developed an electrochemical device for dissolved oxygen removal from water to improve circulating water quality and slow down the corrosion of the equipment.

## Research Skill

---

- Extensive experience in material preparation method: hydrothermal synthesis, ultrasonic synthesis, electrodeposition, electroless deposition, coating.
- Experienced with surface treatment methods: electroplating, electroless plating, anodizing, electrochemical polishing, electrochemical etching.
- Good at material characterization methods: SEM, EDS, TEM, AFM, XRD, Raman, FTIR, UV-vis DR, XPS, UPS.
- Proficient in diverse electrochemical measurements: EIS, RRDE, cyclic and linear sweep voltammetry, potentiodynamic polarization, Mott-Schottky test, micro-area scanning electrochemical technology (SVET, LEIS, SKP, SECM), wire beam electrode, electrochemical noise.
- **IELTS** Overall Band Score: **6.5**.

## RESEARCH INTERESTS

---

Energy storage material; Electrochemistry; Surface & interface; Metal Corrosion; Semiconductor material

## Honors & Awards

---

Sept. 2019 Learning Excellence Scholarship (first-class)  
 Sept. 2018 Learning Excellence Scholarship (first-class)  
 Sept. 2017 Learning Excellence Scholarship (first-class)  
 Dec. 2016 National Encouragement Scholarship  
 Oct. 2016 Learning Excellence Award (Second Prize)  
 Dec. 2014 National Encouragement Scholarship  
 Oct. 2014 Learning Excellence Award (Second Prize)